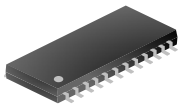
16-BIT CONSTANT CURRENT LED DRIVER

DESCRIPTION

SC6616 is a constant current LED driver. It includes shift register, data latches, constant current drivers and etc. There are 16-channel constant current output, with 1-35mA current available at each channel. This constant current can be set through an external resistor.



SSOP-24-300-1.0

SSOP-24-225-0.635

FEATURES

- Compatible with general driver IC
- Excellent low gray performance
- 16-channel CC(constant current) output
- Output current adjustable through external resistor
- Output current: 1-35mA@5V
- 1-25mA@3.3V
- Data serial-in/serial-out
- 30MHz DCLK frequency
- Fast output current response, $\overline{OE}$ min. width: 20ns
- Current accuracy

Accuracy	
Between channels (typ.)	Between ICs(typ.)
±1%	±1.5%

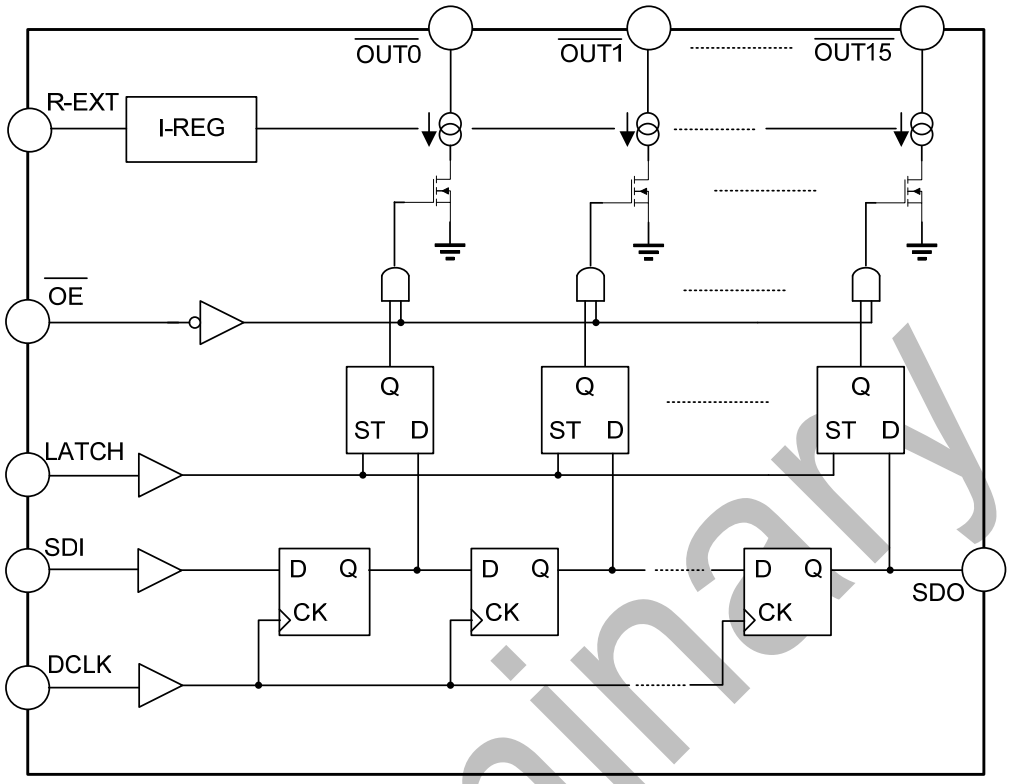
APPLICATION

- LED screen

ORDERING INFORMATION

Part No.	Package	Marking	Material	Packing
SC6616P	SSOP-24-300-1.0	SC6616P	Halogen free	Tube
SC6616PTR	SSOP-24-300-1.0	SC6616P	Halogen free	Tape & Reel
SC6616S	SSOP-24-225-0.635	SC6616S	Halogen free	Tube
SC6616STR	SSOP-24-225-0.635	SC6616S	Halogen free	Tape & Reel

BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATING

Characteristics		Symbol	Ratings	Unit
Supply Voltage		V_{DD}	6	V
Input Voltage		V_{IN}	-0.2~V_{DD}+0.2	V
Output Current		I_{OUT}	35	mA/ch
Output withstand Voltage		V_{DS}	-0.2~ 10	V
Power Dissipation (T_{amb}=25°C)	SC6616S	P_{D1}	1.79	W
	SC6616P	P_{D2}	1.89	W
Thermal Resistance	SC6616S	$R_{th(j-a)1}$	70	°C/W
	SC6616P	$R_{th(j-a)2}$	66	°C/W
Storage Temperature		T_{stg}	-55~+150	°C
Operating Temperature		T_{opr}	-40 ~ 85	°C

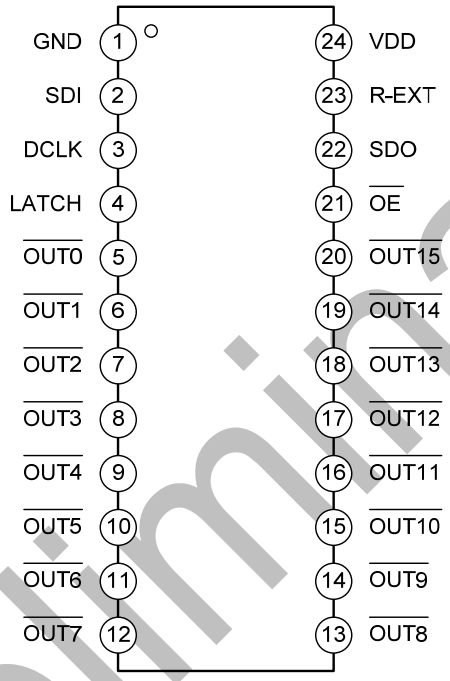
ELECTRICAL CHARACTERISTICS (Unless otherwise specified, T_{amb}=25°C, V_{DD}=5V)

Characteristics	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Supply Voltage	V_{DD}	-	3.0	-	5.5	V
CC output current	I_{OUT}	V_{DD}=5V, V_{OUT}=1V	1	-	35	mA/ch
		V_{DD}=3.3V, V_{OUT}=1V	1	-	25	mA/ch

Characteristics	Symbol	Test Condition		Min.	Typ.	Max.	Unit
Port voltage of CC source	V_{DS}	Constant current source is off		-	-	9	V
		Constant current source is on R_{EXT}=2.4KΩ		0.5	-	-	V
Output current	I_{OUT1}	V_{DD}=5V, $_{OUT}$=1V	R_{EXT}=806Ω	-	23.2	-	mA
	I_{OUT2}	V_{DD}=5V, $_{OUT}$=1V	R_{EXT}=9kΩ	-	2.08	-	mA
Output current difference	$\triangle I_{OUT}$	Between channels	V_{OUT}>0.7V	-	±1	±2.5	%
		Between ICs	R_{EXT}<4.7KΩ	-	±1.5	±3	%
R-EXT voltage	V_{R-EXT}			1.235	1.255	1.275	V
Output leakage current	I_{LEAK}	Constant current source is off V_{OUT}=9V		-	-	1	uA
SDO high output voltage	I_{SDOH}	V_{DD}=3.3V, V_{SDO}=3V		0.8	1.17	-	mA
		V_{DD}=5V, V_{SDO}=4.7V		0.9	1.28	-	mA
SDO low output voltage	I_{SDOL}	V_{DD}=3.3V, V_{SDO}=0.3V		0.75	1.08	-	mA
		V_{DD}=5V, V_{SDO}=0.3V		0.8	1.15	-	mA
Output current regulation	%/V_{DD}	V_{DD}: 3.0V—5.0V		-	0.5	2	%
Pull-down resistance at LATCH	R_{PD}	-		400	500	600	KΩ
Pull-up resistance at $\overline{OE}$	R_{PU}	-		400	500	600	KΩ
Operating current (shutdown)	I_{OFF}	R_{EXT}=806Ω		3.5	5	6.5	mA
Operating current (on)	I_{ON}	R_{EXT}=806Ω		15	18	21	mA
SDI high input voltage	V_{IH}	-		0.8V_{DD}	-	V_{DD}+0.15	V
SDI low input voltage	V_{IL}	-		-0.15	-	0.2V_{DD}	V
DCLK frequency	F_{DCLK}	-		-	-	30	MHz
LATCH set-up time	t_{su}(L)	-		10	-	-	nS
LATCH hold time	t_h(L)	-		10	-	-	nS
LATCH pulse width	t_{LATCH}	-		20	-	-	nS
DCLK pulse width	t_{DCLK}	-		15	-	-	nS
$\overline{OE}$ pulse width	t_{OE}	-		20	-	-	nS
DCLK set-up time	t_{su}(C)	-		10	-	-	nS
DCLK hold time	t_h(C)	-		10	-	-	nS
Transmission delay time (“L” to “H”)	t_{pLH1}	LATCH - $\overline{OUTn}$, $\overline{OE}$ =“L”		25	30	35	ns
	t_{pLH2}	$\overline{OE}$ - $\overline{OUTn}$		25	30	35	ns
	t_{pLH3}	DCLK—SDO		20	25	30	ns

Characteristics	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Transmission delay time ("H" to "L")	t_{pHL1}	LATCH - $\overline{OUTn}$, $\overline{OE}$ ="L"	25	30	35	ns
	t_{pHL2}	$\overline{OE}$ - $\overline{OUTn}$	25	30	35	ns
	t_{pHL3}	DCLK—SDO	20	25	30	ns
Max. DCLK rising time	t_r	-	-	-	500	ns
Max. DCLK falling time	t_f	-	-	-	500	ns

PIN CONFIGURATION



SC6616P/SC6616S

PIN DESCRIPTION

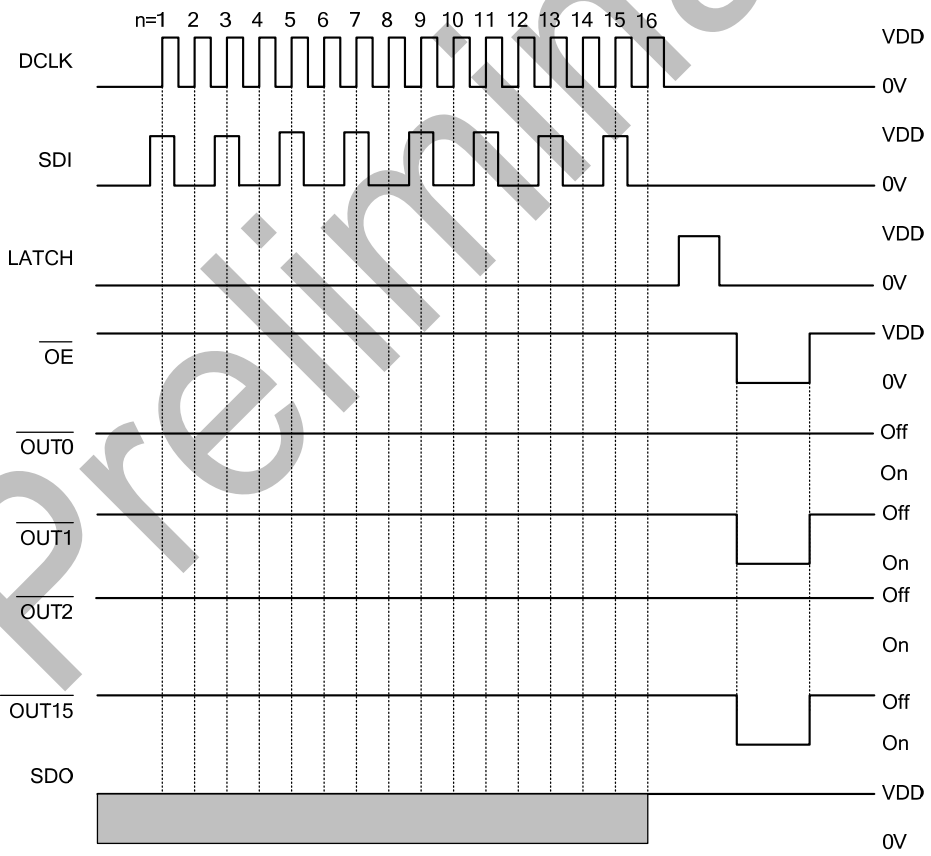
Pin No. SC6616P/S	Pin Name	I/O	Description
1	GND	--	Ground
2	SDI	I	Serial data input of shift register
3	DCLK	I	Clock input of shift register
4	LATCH	I	Data latch control pin of shift register
5 ~ 20	$\overline{OUT0}$ ~ $\overline{OUT15}$	I/O	CC outputs 0~15
21	$\overline{OE}$	I	16-channel CC output enable pin (active low)
22	SDO	O	Serial data output of shift register
23	R-EXT	I/O	The resistor is connected between this pin and ground for 16-channel current setting
24	VDD	--	Power supply

FUNCTION DESCRIPTION

For LED display application, the serial data can be shifted from SDI to internal 16-bit shift register via DCLK riding edge and shifted out at SDO. And the SDO of previous SC6616 can be connected to SDI of the next SC6616 for cascade connection. The data in shift register can be written in data latch when LATCH is high, and data is latched when LATCH is low. The data in data latch is for controlling on/off of 16-channel constant current source. The constant current source is controlled by data latch when $\overline{OE}$ is low, and constant current source is off when $\overline{OE}$ is high, with high impedance output. The current of constant current source can be set through an external resistor connected to R-EXT.

Notes: there is only one ground pin shared as analog/digital/power ground. It is recommenced to adopting the routing with minimum inductance to reduce conversion noise caused by input signal and fault caused by output current. The proper output voltage is needed for better constant current output, and the minimum output voltage can be obtained according to the electrical characteristics. To avoid noise on current, the resistor should be placed near pin R-EXT with shortest routing from GND of resistor to PIN1 of SC6616.

Time sequence DIAGRAM



Note: the data in shift register is shifted by DCLK rising edge.

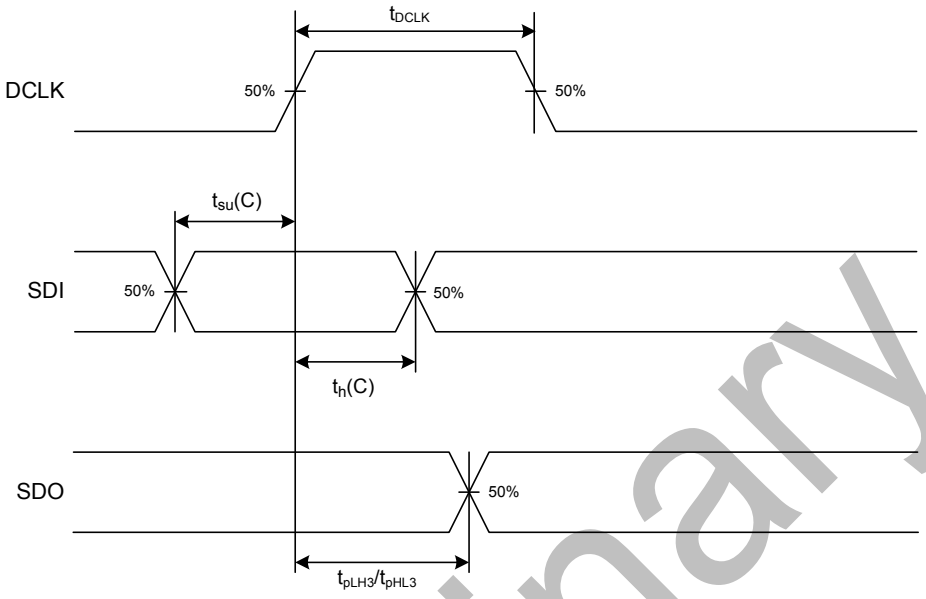
The data in shift register is written in data latch when LATCH is high, and data is latched when LATCH is low.

The output is enabled when $\overline{OE}$ is low.

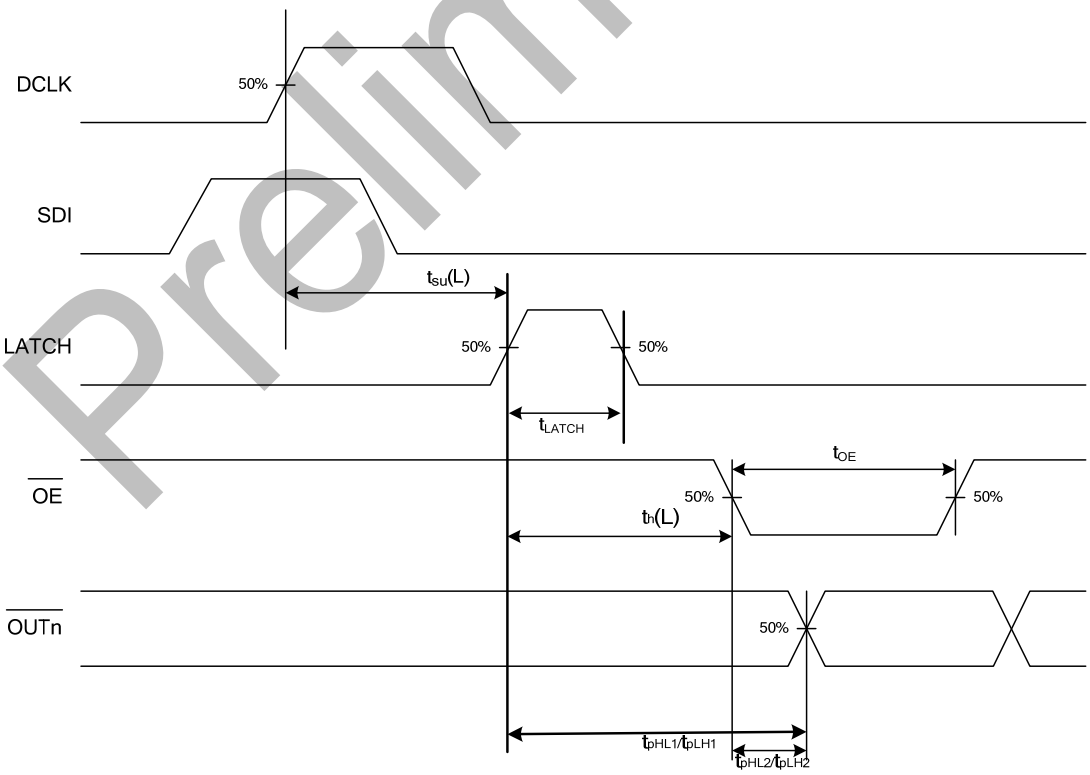
When $\overline{OE}$ is high, output is off, and the status is high impedance.

TIME SEQUENCE WAVEFORM

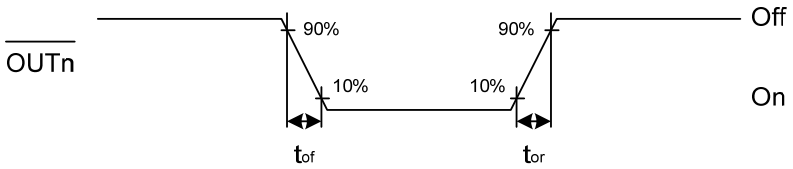
1. DCLK, SDI, SDO



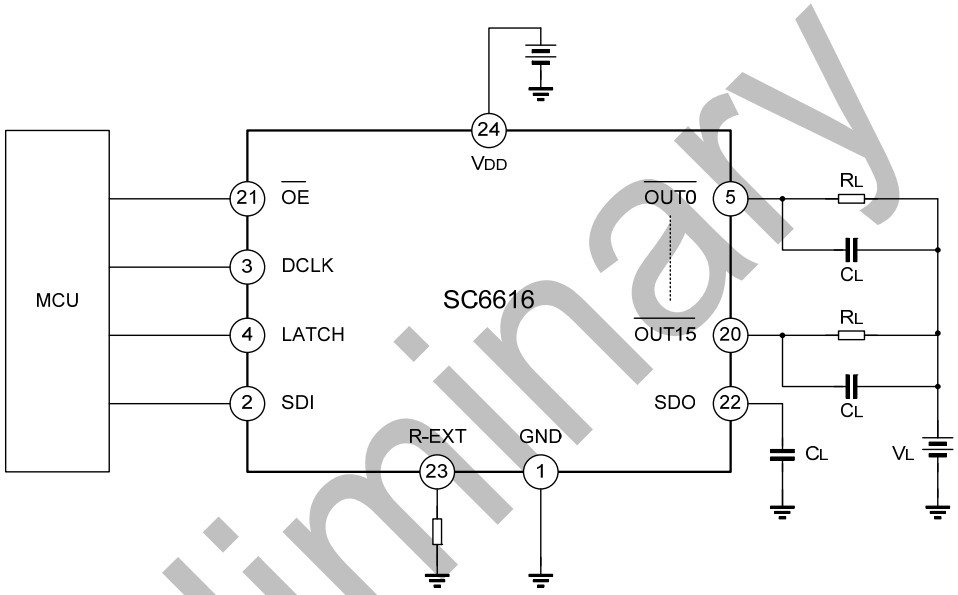
2. DCLK, SDI, LATCH, $\overline{OE}$, $\overline{OUTn}$



3. $\overline{OUTn}$



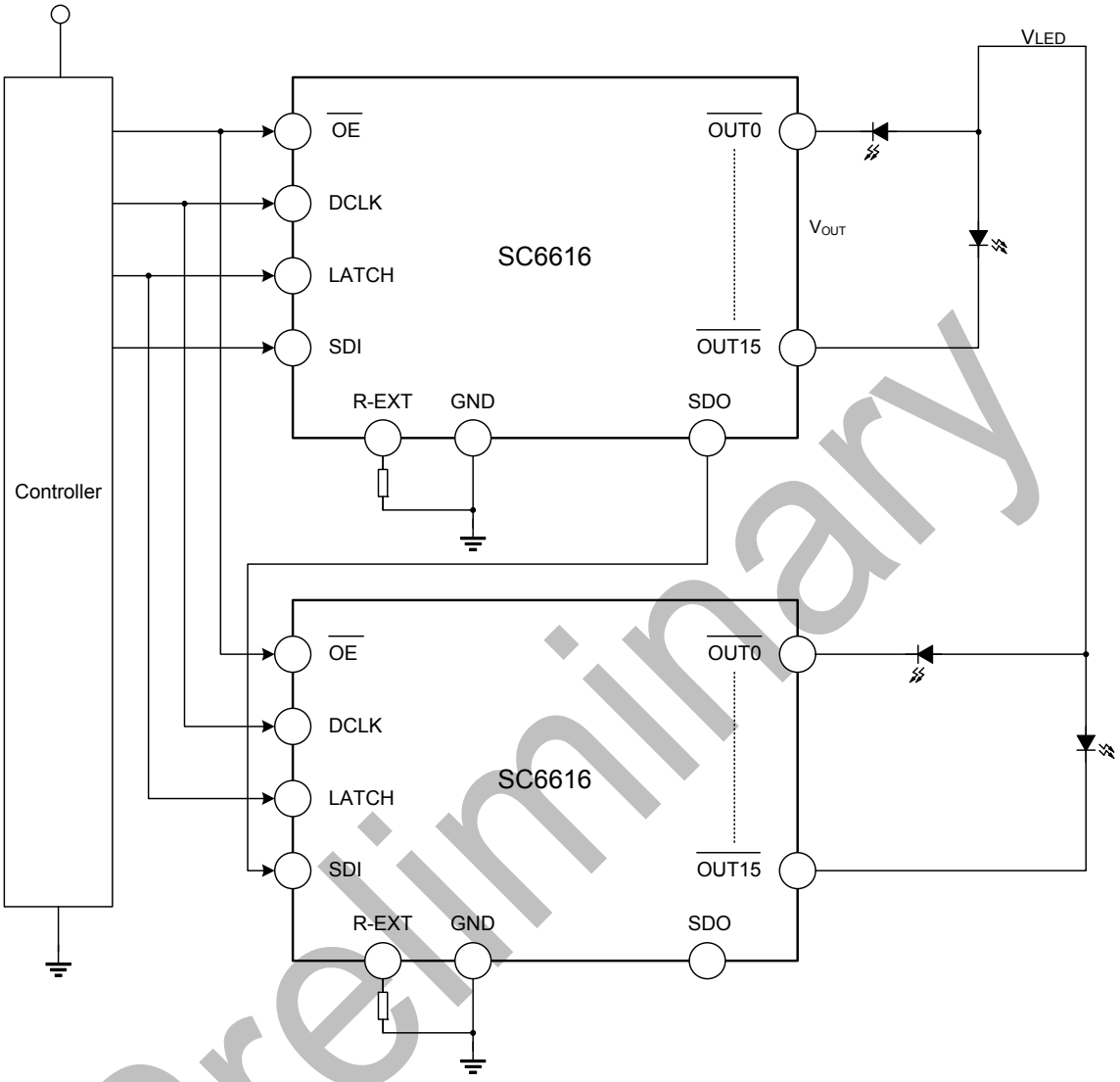
TEST CIRCUIT



Test condition: just for circuit above

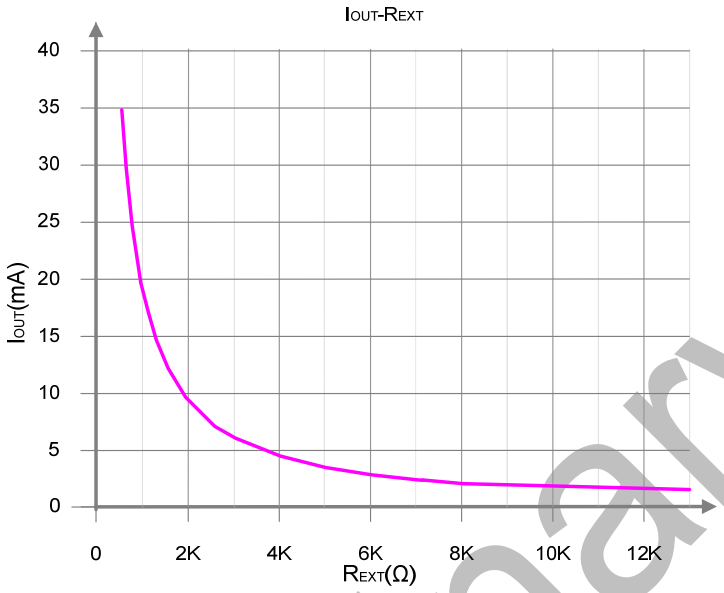
T_{opr}=25°C, V_{DD}=3.3V or 5V, R_{EXT}=910Ω, V_L=5.0V, R_L=180Ω, C_L=10pF

TYPICAL APPLICATION CIRCUIT



Note: the circuit and parameter above are only for reference, please set the parameter according to practical circuit.

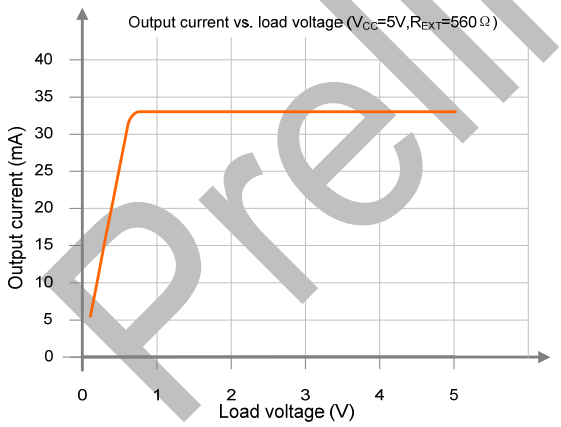
CHARACTERISTIC CURVE

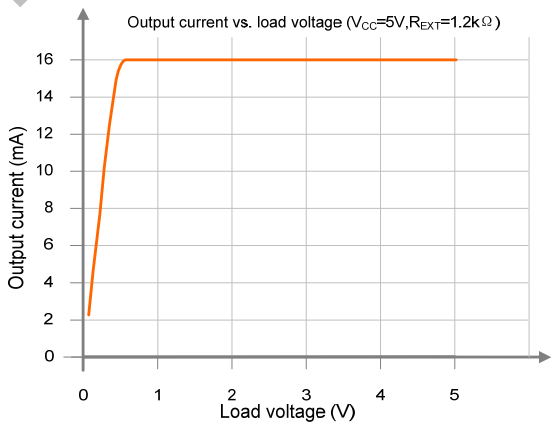


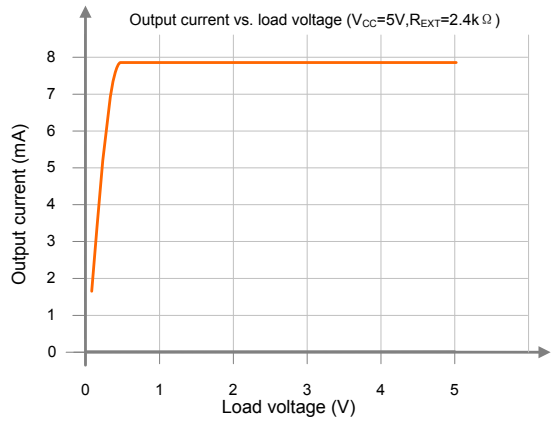
Formula:

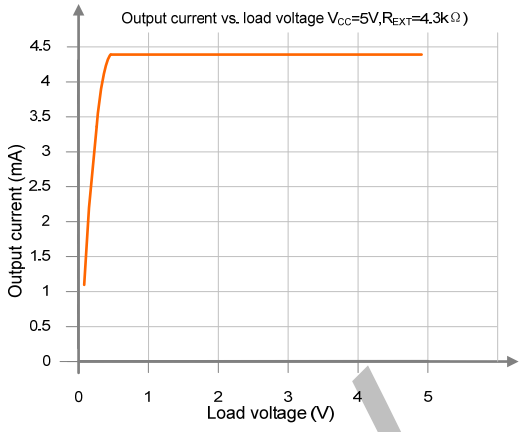
$I_{OUT} = (V_{R\text{-}EXT} / R_{EXT}) \times 15$; $V_{R\text{-}EXT} = 1.255V$

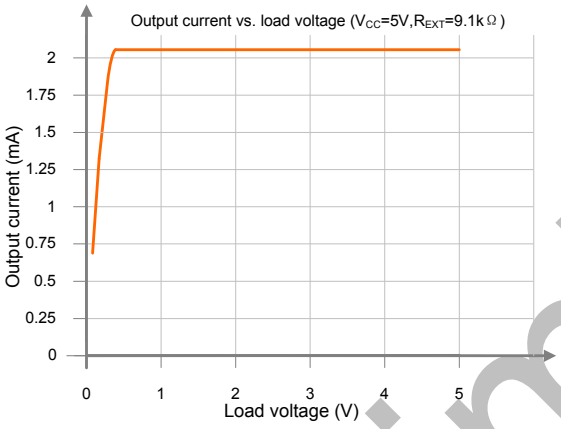
Where, $V_{R\text{-}EXT}$ is voltage at R-EXT, R_{EXT} is external resistance connected to R-EXT.

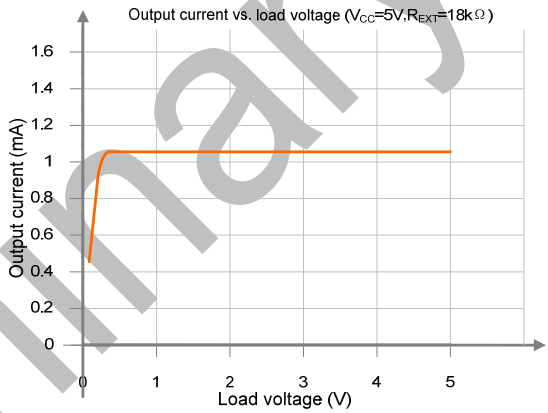






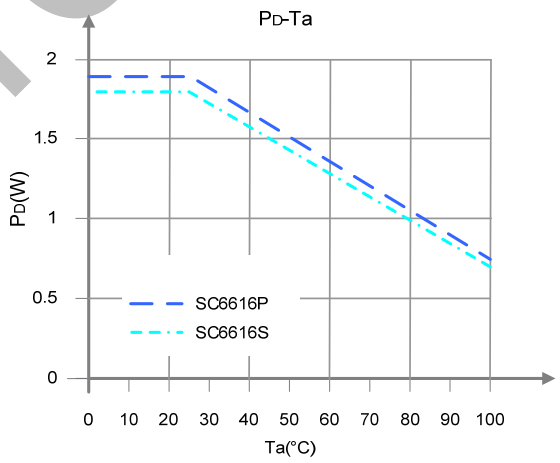






Power dissipation (PD)

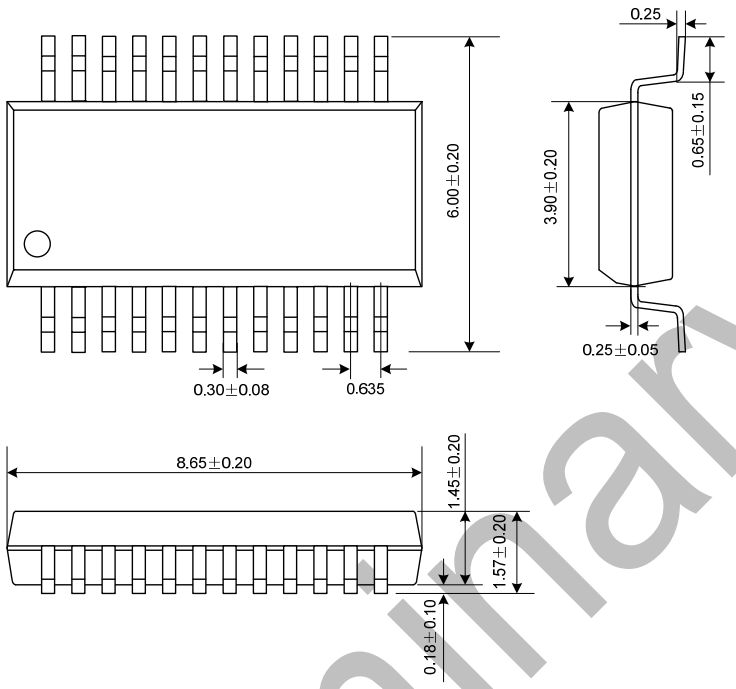
The maximum power dissipation is given by: $P_{D(max)}=(T_j-T_a)/R_{th(j-a)}$. When 16-channel are all on, the actual power dissipation is given by: $P_{D(act)}=(I_{DD} \times V_{DD})+(I_{OUT} \times V_{CE} \times 16)$.



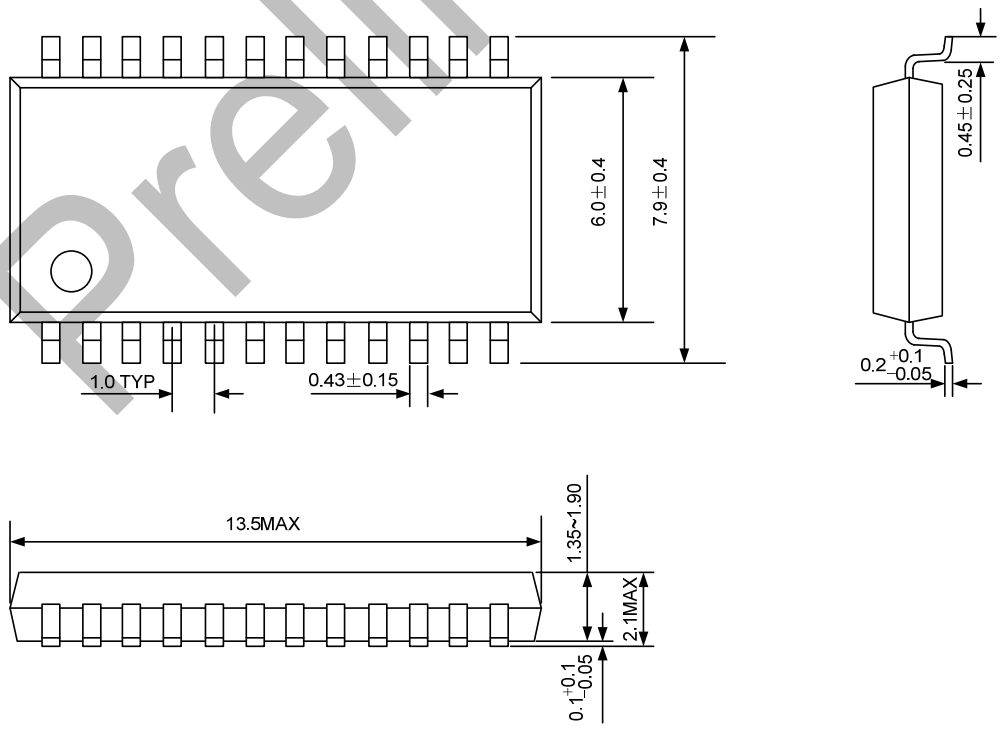
The maximum power is affected by various factors, such as ambient environment, humidity. The data above is tested the limit in special environment, and it is only for reference. The margin will be considered during mass production and the data will be tested.

PACKAGE OUTLINE

SSOP-24-225-0.635 UNIT: mm



SSOP-24-300-1.0 UNIT: mm



MOS DEVICES OPERATE NOTES:

Electrostatic charges may exist in many things. Please take following preventive measures to prevent effectively the MOS electric circuit as a result of the damage which is caused by discharge:

- The operator must put on wrist strap which should be earthed to against electrostatic.
- Equipment cases should be earthed.
- All tools used during assembly, including soldering tools and solder baths, must be earthed.
- MOS devices should be packed in antistatic/conductive containers for transportation.

Disclaimer :

- **Silan reserves the right to make changes to the information herein for the improvement of the design and performance without further notice! Customers should obtain the latest relevant information before placing orders and should verify that such information is complete and current.**
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